

SEMICONDUCTORTM

March 1993 Revised March 1999

# 74VHC393 **Dual 4-Bit Binary Counter**

#### **General Description**

The VHC393 is an advanced high speed CMOS 4-bit Binary Counter fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. It contains two independent counter circuits in one package, so that counting or frequency division of 8 binary bits can be achieved with one IC. This device changes state on the negative going transition of the  $\overline{\text{CLOCK}}$  pulse. The counter can be reset to "0" ( $Q_0 - Q_3 =$ "L") by a HIGH at the CLEAR input regardless of other inputs.

An input protection circuit ensures that 0V to 7V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

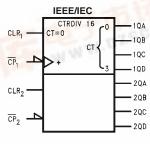
- High Speed: f<sub>MAX</sub> = 170 MHz (typ) at T<sub>A</sub> = 25°C
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max) at } T_A = 25 ^{\circ} C$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Power down protection is provided on all inputs
- Pin and function compatible with 74HC393

### Ordering Code:

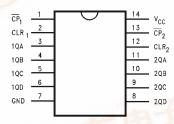
Order Number	Package Number	Package Description
74VHC393M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
74VHC393SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHC393MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC393N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

## **Logic Symbol**



## **Connection Diagram**



#### **Pin Descriptions**

Pin Names	Description
CLR1, CLR2	Clear Inputs
CP₁, CP₂	Clock Pulse Inputs
QA, QB, QC, QD	Outputs

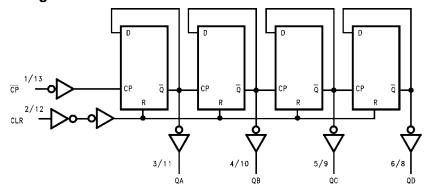


# **Truth Table**

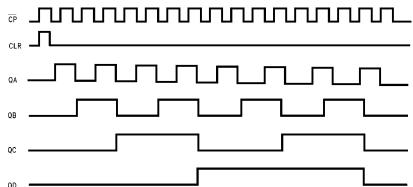
Input	Outputs						
СР	CLR	QA	QB	QC	QD		
Х	Н	L	L	L	L		
Ł	L	Count Up					
<u> </u>	L	No Change					

X: Don't Care

# **System Diagram**



# **Timing Chart**



#### **Absolute Maximum Ratings**(Note 1)

# **Recommended Operating**

-20 mA

±20 mA

Supply Voltage (V<sub>CC</sub>) -0.5V to +7.0V DC Input Voltage (V<sub>IN</sub>) -0.5V to +7.0VDC Output Voltage (V<sub>OUT</sub>) -0.5V to  $V_{CC} + 0.5V$ 

Input Diode Current (I<sub>IK</sub>) Output Diode Current (I<sub>OK</sub>) DC Output Current (I<sub>OUT</sub>)

±25 mA ±75 mA DC V<sub>CC</sub>/GND Current (I<sub>CC</sub>) Storage Temperature (T<sub>STG</sub>) -65°C to +150°C

Lead Temperature (T<sub>L</sub>)

(Soldering, 10 seconds) 260°C Conditions (Note 2)

Supply Voltage (V<sub>CC</sub>) 2.0V to +5.5V 0V to +5.5V Input Voltage (V<sub>IN</sub>)

Output Voltage (V<sub>OUT</sub>) 0V to  $V_{CC}$ Operating Temperature (T<sub>OPR</sub>) -40°C to +85°C

Input Rise and Fall Time  $(t_r, \, t_f)$ 

0 ~ 100 ns/V  $V_{CC}=3.3V\pm0.3V$  $V_{CC} = 5.0V \pm 0.5V$ 0 ~ 20 ns/V

Note 1: Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside databook specifica-

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

#### **DC Electrical Characteristics**

Symbol	Parameter	V <sub>CC</sub>	T <sub>A</sub> = 25°C			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
<b>C</b> y <b>S</b> C.		(V)	Min	Тур	Max	Min	Max	Oille	Conditions	
V <sub>IH</sub>	HIGH Level	2.0	1.50			1.50		V		
	Input Voltage	3.0 - 5.5	0.7 V <sub>CC</sub>			0.7 V <sub>CC</sub>		v		
V <sub>IL</sub>	LOW Level	2.0			0.50		0.50	V		
	Input Voltage	3.0 - 5.5			$0.3\mathrm{V}_{\mathrm{CC}}$		0.3 V <sub>CC</sub>	V		
V <sub>OH</sub>	HIGH Level	2.0	1.9	2.0		1.9			$V_{IN} = V_{IH}$	$I_{OH} = -50 \mu A$
	Output Voltage	3.0	2.9	3.0		2.9		V	or V <sub>IL</sub>	
		4.5	4.4	4.5		4.4				
		3.0	2.58			2.48		V	İ	$I_{OH} = -4 \text{ mA}$
		4.5	3.94			3.80		V		$I_{OH} = -8 \text{ mA}$
V <sub>OL</sub>	LOW Level	2.0		0.0	0.1		0.1		$V_{IN} = V_{IH}$	$I_{OL} = 50  \mu A$
	Output Voltage	3.0		0.0	0.1		0.1	V	or V <sub>IL</sub>	
		4.5		0.0	0.1		0.1			
		3.0			0.36		0.44	V	İ	$I_{OL} = 4 \text{ mA}$
		4.5			0.36		0.44	V		$I_{OL} = 8 \text{ mA}$
I <sub>IN</sub>	Input Leakage Current	0 – 5.5			±0.1		±1.0	μΑ	V <sub>IN</sub> = 5.5\	or GND
I <sub>CC</sub>	Quiescent Supply Current	5.5			4.0		40.0	μΑ	$V_{IN} = V_{CC}$	or GND

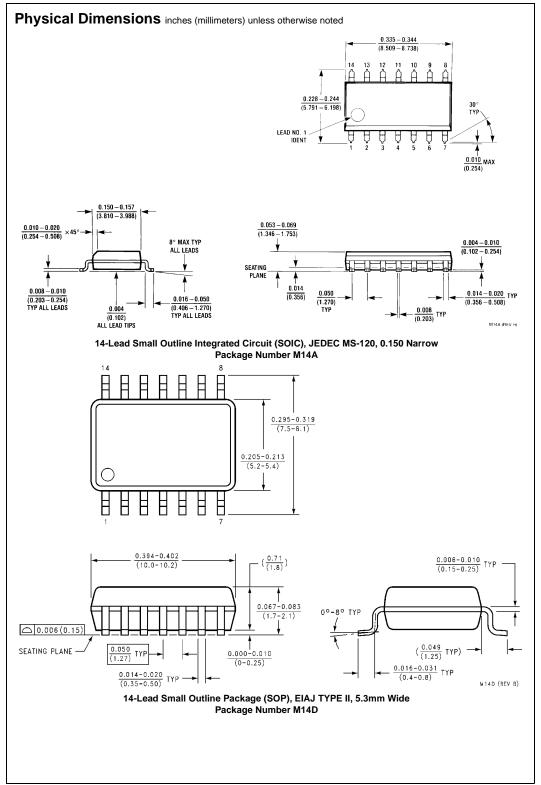
## **AC Electrical Characteristics**

Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = 25°C			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Symbol			Min	Тур	Max	Min	Max	Units	Conditions	
t <sub>PLH</sub>	Propagation	$3.3 \pm 0.3$		8.6	13.2	1.0	15.5	ns	C <sub>L</sub> = 15 pF	
t <sub>PHL</sub>	Delay Time			11.1	16.7	1.0	19.0	115	$C_L = 50 pF$	
	(CP -QA)	$5.0 \pm 0.5$		5.8	8.5	1.0	10.0	no	C <sub>L</sub> = 15 pF	
				7.3	10.5	1.0	12.0	ns	$C_L = 50 pF$	
t <sub>PLH</sub>	Propagation	$3.3 \pm 0.3$		10.2	15.8	1.0	18.5	no	C <sub>L</sub> = 15 pF	
t <sub>PHL</sub>	Delay Time			12.7	19.3	1.0	22.0	ns	$C_L = 50 pF$	
	(CP -QB)	$5.0\pm0.5$		6.8	9.8	1.0	11.5	ns	$C_L = 15 pF$	
				8.3	11.8	1.0	13.5	115	$C_L = 50 pF$	
t <sub>PLH</sub>	Propagation	$3.3 \pm 0.3$		11.7	18.0	1.0	21.0	ns	C <sub>L</sub> = 15 pF	
t <sub>PHL</sub>	Delay Time			14.2	21.5	1.0	24.5	115	$C_L = 50 pF$	
	(CP -QC)	$5.0 \pm 0.5$		7.7	11.2	1.0	13.0	ns	$C_L = 15 pF$	
				9.2	13.2	1.0	15.0	115	$C_L = 50 pF$	
t <sub>PLH</sub>	Propagation	$3.3 \pm 0.3$		13.0	19.7	1.0	23.0	ns	C <sub>L</sub> = 15 pF	
t <sub>PHL</sub>	Delay Time			15.5	23.2	1.0	26.5	110	$C_L = 50 pF$	
	(CP -QD)	$5.0 \pm 0.5$		8.5	12.5	1.0	14.5	ns	C <sub>L</sub> = 15 pF	
				10.0	14.5	1.0	16.5	113	$C_L = 50 pF$	
t <sub>PLH</sub>	Propagation	$3.3 \pm 0.3$		7.9	12.3	1.0	14.5	ns	C <sub>L</sub> = 15 pF	
$t_{PHL}$	Delay Time			10.4	15.8	1.0	18.0	113	$C_L = 50 pF$	
	(CLR-Q <sub>n</sub> )	$5.0 \pm 0.5$		5.4	8.1	1.0	9.5	ns	$C_L = 15 pF$	
				6.9	10.1	1.0	11.5	110	$C_L = 50 pF$	
$f_{MAX}$	Maximum	$3.3 \pm 0.3$	75	120		65			C <sub>L</sub> = 15 pF	
	Clock		45	65		35		MHz	$C_L = 50 pF$	
		$5.0 \pm 0.5$	125	170		105		2	$C_L = 15 pF$	
			85	115		75			$C_L = 50 pF$	
C <sub>IN</sub>	Input Capacitance		-	4	10		10	pF	V <sub>CC</sub> = Open	
C <sub>PD</sub>	Power Dissipation Capacitance			23				pF	(Note 3)	

Note 3: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load Average operating current can be obtained by the equation: I<sub>CC</sub>(opr.) = C<sub>PD</sub>\*V<sub>CC</sub>\*f<sub>IN</sub> + I<sub>CC/2</sub> (per Counter)

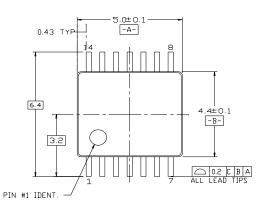
# **AC Operating Requirements**

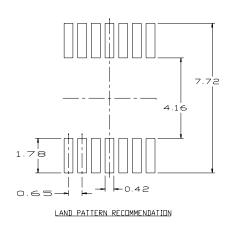
Symbol	Parameter	V <sub>cc</sub>	T <sub>A</sub> =	25°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	Units	
	Farameter	(V)	Тур	Guaran	teed Minimum		
t <sub>W</sub> (L)	Minimum Pulse	$3.3 \pm 0.3$		5.0	5.0		
$t_W(H)$	Width (CP)	$5.0\pm0.5$		5.0	5.0	ns	
t <sub>W</sub> (H)	Minimum Pulse	$3.3 \pm 0.3$		5.0	5.0		
	Width (CLR)	$5.0\pm0.5$		5.0	5.0	ns	
t <sub>REM</sub>	Minimum Removal	$3.3 \pm 0.3$		5.0	5.0	no	
	Time	$5.0 \pm 0.5$		4.0	4.0	ns	

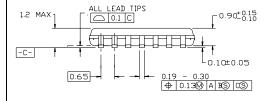


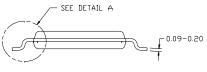
## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

14LD, TSSOP, JEDEC MO-153, 4.4MM WIDE



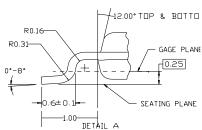




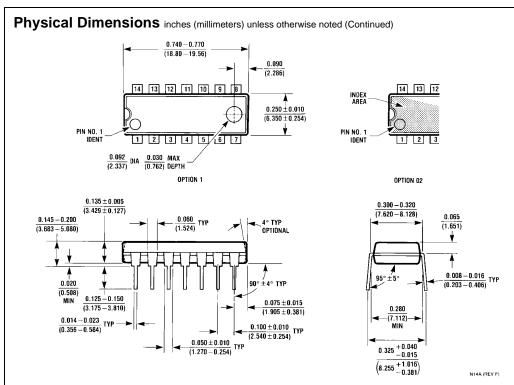


#### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION ABUREF NOTE 6, DATED  $7/93\,$
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14



#### 14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N14A

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